

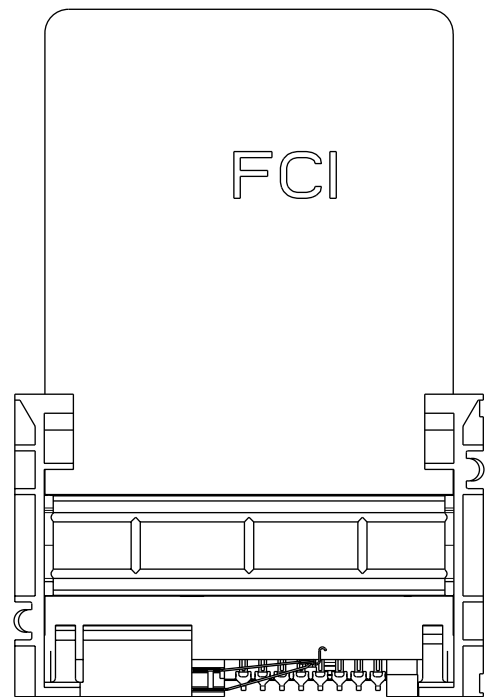
7334L2622F05LF

Catalogue Part Number Key

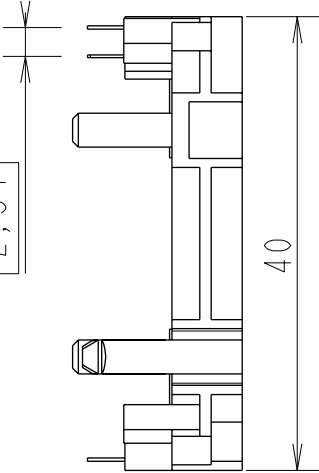
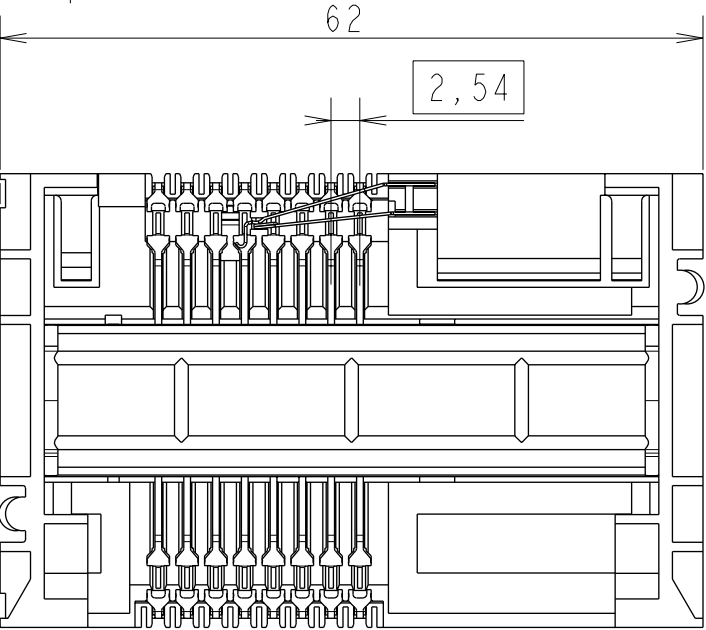
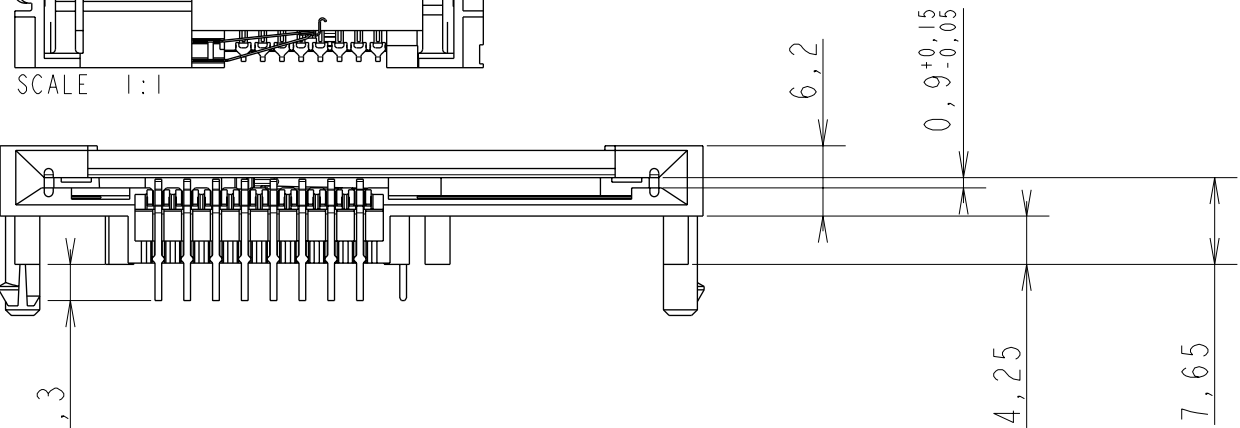
Lead Free Version (Optional)

Durability
0: 2500 Mating Cycles
2: 10000 Mating Cycles
5: 100000 Mating Cycles

Number of contacts :
2: 8 contacts ISO
3: 16 contacts ISO + AFNOR



SCALE 1:1



GENERAL:
This L26 connector uses a "sliding" contact technology suitable for most applications.
It has been designed for easy mounting on the PCB.

ELECTRICAL PROPERTIES:
Insulation resistance : 5000 MΩ min
Dielectric withstanding : 750 Vrms min
Current carrying capacity : 10µA min. 1A max
Contact resistance : 100mΩ max
Card sensor type : Normally closed

MECHANICAL PROPERTIES:
Contact Normal force : 0.6 N max (EMV Standard)
Insertion force : 10 N max
Extraction force : 1 N min

MATERIAL:
Housing : Thermoplastic, Colour Black, Rated UL94V0
Contacts and switch : Copper Alloy
Plating : Gold over Nickel on contact area
Matte Tin over Nickel on solder tails
Bare edge allowed

ENVIRONMENT:
Operating temperature: -20°C / +70°C
Storage temperature: -40°C / +85°C
Printed Circuit Board thickness : 1.6mm

REFERENCE DOCUMENTS:
Product specification VGN 11596
Packaging Specification VGN 11619

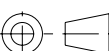
LEAD FREE VERSION:

"This product meets European Union Directives and other country regulations as described in GS-22-008"

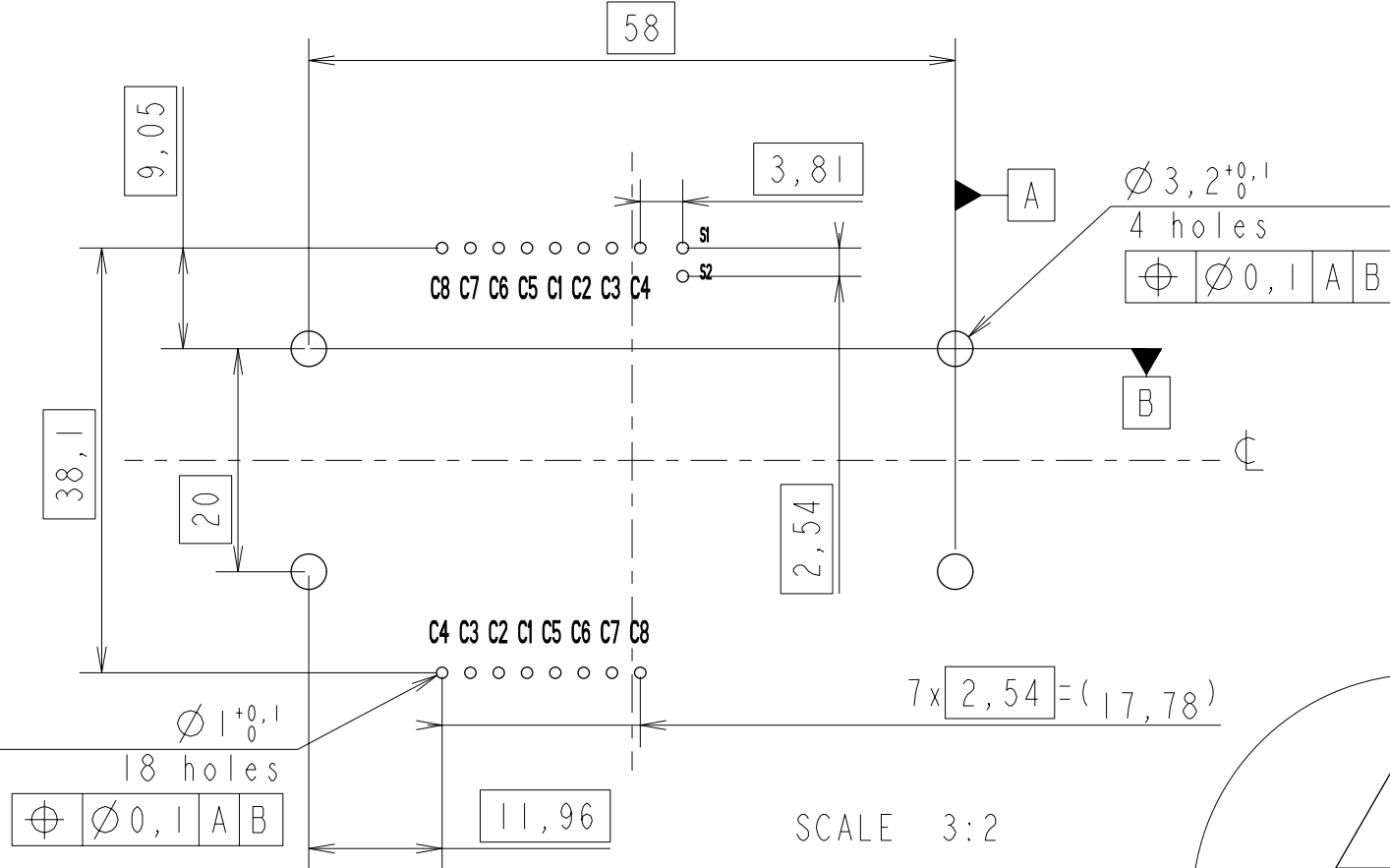
The housing will withstand exposure to 260°C peak temperature for 10seconds in a wave solder application with a 1.6mm minimum thick circuit board. Use protective adhesive tape (Kapton orTeflon) or protective metallic devices on the areas which are directly exposed to wave soldering as it is used in classical leaded wave soldering

General Tolerances: ± 0.2 mm

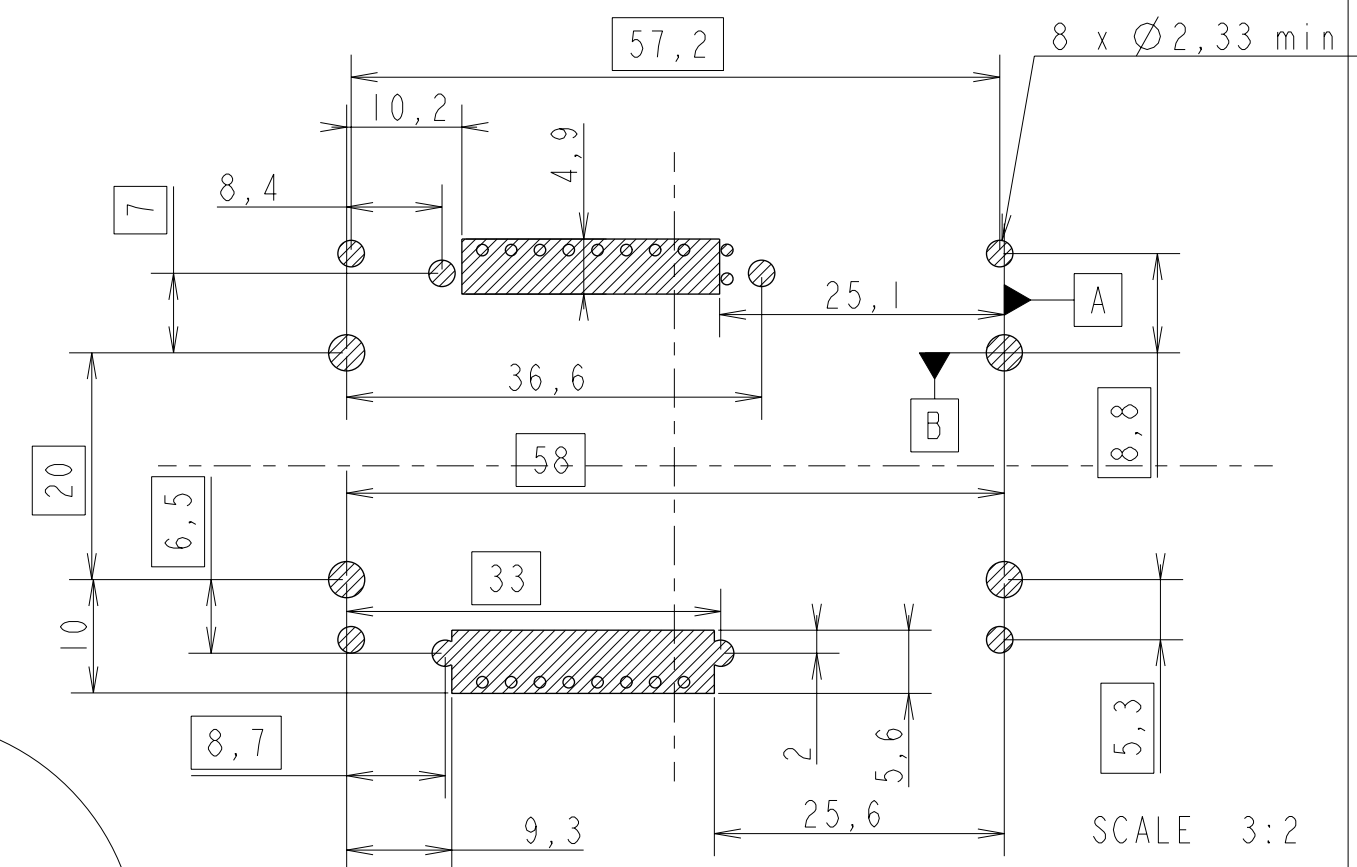
litr	ecn no	dr	date
A	F20307	DLE	2002/04/30
B	LS 3053	JTA	2003/05/13
C	105-0071	DTK	2005/06/25
D	106-0084	SSC	2006/06/21
E	106-0189	SSC	2006/10/17
F	109-0057	SSC	2009/04/15
-	-	-	-

www.fciconnect.com			surface ISO 1302		- / ✓ tolerance std ISO 406 ISO 1101		projection 		mm 			
			TOLERANCES UNLESS OTHERWISE SPECIFIED									
Dr	N.TWINCY	2002/04/30	ANGULAR	LINEAR		0.X	±	size A3	Scale 3:2			
Eng	F TISSERAND	2002/04/30				0.XX	±					
Chr	RAMESH.P.K	2009/04/15				0°	±°				0.XXX	±
Appr	S.S.CHERIAN	2009/04/15	Product family SMART CARDS					ECN 109-0057				
								Spec ref		SEE NOTES		
			title L26 TYPE F05 --					dwg no VJW_54705			Rev. F	
			catalog no					SEE TABLE			-	

RECOMMENDED PCB LAYOUT CONTACT CONFIGURATION : ISO & AFNOR
(CONNECTOR SIDE)

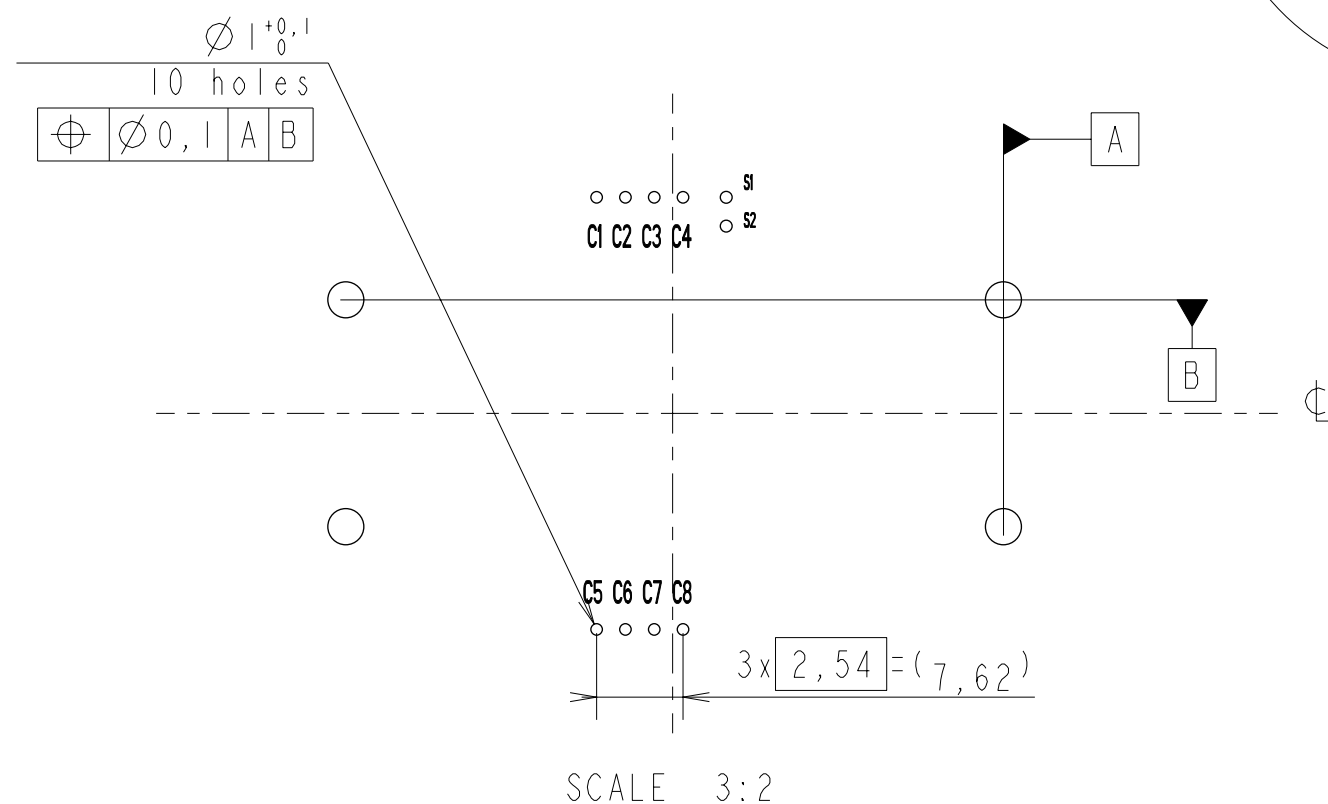


STANDARD LAYOUT FOR 'KEEP OUT ZONE' (Connector Side)

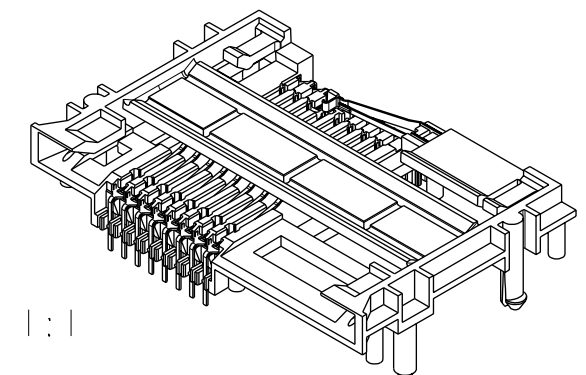


Hatching area might be free of components
Maximum free space outside of these zones = 4.25 mm

RECOMMENDED PCB LAYOUT CONTACT CONFIGURATION : ISO
(CONNECTOR SIDE)

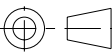


CARD
INSERTION



ECHELLE 1:1

EUROPEAN PROJECTION

www.fciconnect.com			surface - 		tolerance std ISO 1302 ISO 406 ISO 1101				
			TOLERANCES UNLESS OTHERWISE SPECIFIED						
Dr	N.TWENCY	2002/04/30	ANGULAR	LINEAR	0.X	±	size A3	Scale 3:2	
Eng	F TISSERAND	2002/04/30			0.XX	±			
Chr	RAMESH.P.K	2009/04/15	0°	±°	0.XXX	±	ECN	109-0057	
Appr	S.S.CHERIAN	2009/04/15	Product family SMART CARDS			Spec ref SEE NOTES			
			title L26 TYPE F05 --			dwg no VJW_54705			Rev. F
catalog no			SEE TABLE			-		sheet 2 of 2	